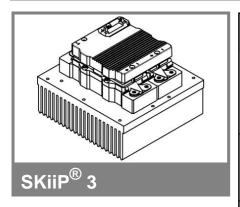
SKiiP 1013GB172-2DL



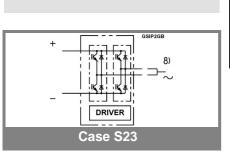
2-pack-integrated intelligent Power System

Power Section SKiiP 1013GB172-2DL

Preliminary Data

Features

- SKiiP technology inside
- · Trench IGBTs
- · CAL diode technology
- · Integrated current sensor
- Integrated temperature sensor
- · Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP[®] 3 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532
- with assembly of suitable MKP capacitor per terminal (SEMIKRON type is recommended)
- AC connection busbars must be connected by the user; copper busbars available on request

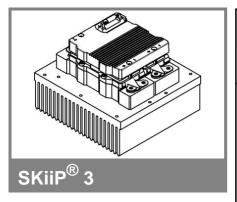


Absolute	Maximum Ratings T _s	s = 25 °C unless otherwise specified				
Symbol	Conditions	Values	Units			
IGBT						
V_{CES}		1700	V			
V _{CES} V _{CC} 1)	Operating DC link voltage	1200	V			
V_{GES}		± 20	V			
I _C	T _s = 25 (70) °C	1000 (750)	Α			
Inverse diode						
$I_F = -I_C$	$T_s = 25 (70) ^{\circ}C$	830 (630)	Α			
I _{FSM}	$T_j = 150 ^{\circ}\text{C}, t_p = 10 \text{ms}; \text{sin}$	6900	Α			
I ² t (Diode)	Diode, T _j = 150 °C, 10 ms	238	kA²s			
T _j , (T _{stg})		- 40 + 150 (125)	°C			
V _{isol}	rms, AC, 1 min, main terminals to heat sink	4000	V			
I _{AC-terminal}	per AC terminal, rms, T _s = 70 °C,	400	Α			
	T _{terminal} ≤ 115 °C					

Characteristics			T _s = 25 °C unless otherwise specified						
Symbol	ymbol Conditions			min.	typ.	max.	Units		
IGBT									
V _{CEsat}	I _C = 600 A measured at t	, T _j = 25 (1 erminal	25) °C;			1,9 (2,2)	2,4	V	
V_{CEO}	$T_{i} = 25 (12)$					1 (0,9)	1,2 (1,1)	V	
r_{CE}	$T_i = 25 (12)$					1,5 (2,1)	1,9 (2,5)	mΩ	
I _{CES}	$V'_{GE} = 0 \text{ V, } V_{CE} = V_{CES},$ $T_i = 25 (125) \text{ °C}$				2,4 (144)		mA		
E _{on} + E _{off}	$I_{\rm C} = 600 {\rm A}$, V _{CC} = 90	0 V			390		mJ	
	T _j = 125 °C	C, V _{CC} = 12	200 V			575		mJ	
R _{CC+EE}	terminal ch	nip, T _i = 25	°C			0,25		mΩ	
L _{CE}	top, botton	n [']				6		nΗ	
C _{CHC}	per phase,	, AC-side				3,4		nF	
Inverse o	diode								
$V_F = V_{EC}$	I _F = 600 A, measured at t		25) °C			2 (1,8)	2,15	V	
V_{TO}	$T_i = 25 (12)$	25) °C				1,1 (0,8)	1,2 (0,9)	V	
r _T	$T_i = 25 (12)$					1,5 (1,7)	1,6 (1,8)	mΩ	
E _{rr}	$I_{\rm C} = 600 {\rm A}$, V _{CC} = 90	0 V			72		mJ	
	T _j = 125 °C	C, V _{CC} = 12	200 V			86		mJ	
Mechani	cal data								
M_{dc}	DC termina	als, SI Uni	ts		6		8	Nm	
M _{ac}	AC terminals, SI Units			13		15	Nm		
W	SKiiP® 3 System w/o heat sink				1,7		kg		
W	heat sink					5,4		kg	
Thermal characteristics (PX 16 heat sink with fan SKF 16B-230-1); "s" reference to heat sink; "r" reference to built-in temperature sensor (acc. IEC 60747-15)									
R _{th(j-s)I}	per IGBT				ĺ		0,03	K/W	
R _{th(j-s)D}	per diode						0,058	K/W	
Z _{th}	R _i (mK/W)	(max. valu	ues)		I				
"	1	2	3	4	1	tau 2	3	4	
$Z_{\text{th(j-r)I}}$	9,8	16,4	3,8	0	0,37	0,06	0,01	1	
$Z_{\text{th(j-r)D}}$	10	24	24	36	50	5	0,25	0,04	
Z _{th(r-a)}	4,3	20,3	7,1	2,3	160	53	9	0,4	

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee, expressed or implied is made regarding delivery, performance or suitability.

SKiiP 1013GB172-2DL



2-pack-integrated intelligent Power System

2-pack integrated gate driver SKiiP 1013GB172-2DL

Preliminary Data

Gate driver features

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and

DC-bus voltage (option)

- Short circuit protection
- · Over current protection
- Over voltage protection (option)
- Power supply protection against under voltage
- Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 60068-1 (climate) 40/85/56
- UL recognized file no. 242581

Absolute	Maximum Ratings T _a	Γ _a = 25 °C unless otherwise specified		
Symbol	Conditions	Values	Units	
V_{S2}	unstabilized 24 V power supply	30	V	
V_{i}	input signal voltage (high)	15 + 0,3	V	
dv/dt	secondary to primary side	75	kV/μs	
V_{isollO}	input / output (AC, rms,)	4000	V	
V _{isoIPD}	partial discharge extinction voltage, rms, Q _{PD} pC;	1500	V	
V _{isol12}	output 1 / output 2 (AC, rms,)	1500	V	
f _{sw}	switching frequency	14	kHz	
f _{out}	output frequency for I=I _C ; sin.	1	kHz	
$T_{op} (T_{stg})$	operating / storage temperature	- 40 + 85	°C	

Characte	eristics T _i	a = 25 °C unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
V_{S2}	supply voltage non stabilized	13	24	30	V
I _{S2}	V _{S2} = 24 V	320+23*f/	320+23*f/kHz+0,00022*(I _{AC} /A) ²		
V _{iT+}	input threshold voltage (High)			12,3	V
V_{iT-}	input threshold voltage (Low)	4,6			V
R _{IN}	input resistance		10		kΩ
C _{IN}	input capacitance		1		nF
t _{d(on)IO}	input-output turn-on propagation time		1,3		μs
t _{d(off)IO}	input-output turn-off propagation time		1,3		μs
t _{pERRRESET}	error memory reset time		9		μs
t_{TD}	top / bottom switch interlock time		3,3		μs
I _{analogOUT}	max. 5mA; 8 V corresponds to 15 V supply voltage for external components		1000		Α
I _{s1out}	max. load current			50	mA
I _{TRIPSC}	over current trip level (I _{analog} OUT = 10 V) over temperature protection	110	1250	120	A °C
U _{DCTRIP}	U _{DC} -protection (U _{analog OUT} = 9 V);		not implemented		V
	(option for GB types)				

For electrical and thermal design support please use SEMISEL. Access to SEMISEL is via SEMIKRON website http://www.semikron.com.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee, expressed or implied is made regarding delivery, performance or suitability.

